

RoHS Reach Halogen Free Pb Free

交货型号	C2012X6S1V335KT****	
用途	一般等级	
特点	<mark>General</mark> 一般 (~75V)	
系列	C2012 [EIA 0805]	
状态	▲ 量产体制(新设计非推荐)	

J	रेर्ग
长度(L)	2.00mm ±0.20mm
宽度(W)	1.25mm ±0.20mm
厚度(T)	1.25mm ±0.20mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	0.50mm Min.
推荐焊盘布局 (PA)	1.00mm to 1.30mm(Flow Soldering)
1世行/产血/中/可 (I A)	0.90mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PB)	1.00mm to 1.20mm(Flow Soldering)
1世行/产血/中/可(LD/	0.70mm to 0.90mm(Reflow Soldering)
推荐焊盘布局(PC)	0.80mm to 1.10mm(Flow Soldering)
1世行/干血/叩内 (1 0)	0.90mm to 1.20mm(Reflow Soldering)

	电气特性	
电容	3.3 μ F $\pm 10\%$	
额定电压	35VDC	
温度特性	X6S (±22%)	
耗散因数 (Max.)	7.5%	
	151ΜΩ	

	其他
焊接方法	流体
件按刀伍	回流
AEC-Q200	NO
包装形式	塑封编带 (180mm卷筒)
包装个数	2000pcs

 $!\ \mbox{Images}$ are for reference only and show exemplary products.

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! All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

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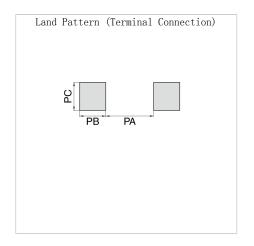
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Associated Images



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